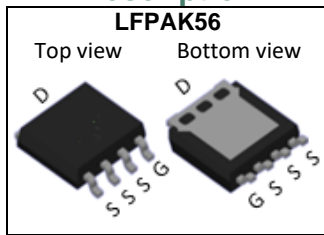
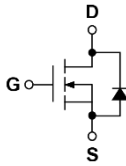


N-Channel Enhancement Mode MOSFET

Pin Description



Symbol



Product Summary

Symbol	N-Channel	Unit
V_{DSS}	40	V
$R_{DS(ON)-Max}$	0.9	m Ω
I_D	318	A

Feature

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS and Rg Tested
- Moisture Sensitivity Level MSL1

Applications

- DC-to-DC converters
- Switch Mode Power Supply
- Brushless DC motor control

Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
SL318N04M	LFPAK56	Tape & Reel	4000 / Tape & Reel	

Absolute Maximum Ratings (T_J=25°C Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
V_{DSS}	Drain-Source Voltage	40	V
V_{GSS}	Gate-Source Voltage	±20	
T_J	Maximum Junction Temperature	175	°C
T_{STG}	Storage Temperature Range	-55 to 175	°C
I_S	Diode Continuous Forward Current	$T_C=25^\circ\text{C}$ 100	A
I_{SP}	Diode Pulse Current	$T_C=25^\circ\text{C}$ 400 ^①	A
I_{DM}	Pulse Drain Current Tested	$T_C=25^\circ\text{C}$ 800 ^①	A
I_D	Continuous Drain Current	$T_C=25^\circ\text{C}$ 318	A
		$T_C=100^\circ\text{C}$ 225	
P_D	Maximum Power Dissipation	$T_C=25^\circ\text{C}$ 125	W
		$T_C=100^\circ\text{C}$ 62.5	
I_D	Continuous Drain Current	$T_A=25^\circ\text{C}$ 52	A
		$T_A=70^\circ\text{C}$ 44	
P_D	Maximum Power Dissipation	$T_A=25^\circ\text{C}$ 3.3	W
		$T_A=70^\circ\text{C}$ 2.3	
$I_{AS}^{②}$	Avalanche Current, Single pulse	L=0.1mH 64	A
		L=0.5mH 34	
$E_{AS}^{②}$	Avalanche Energy, Single pulse	L=0.1mH 204	mJ
		L=0.5mH 290	

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	Steady State	1.2 °C/W
$R_{\theta JA}^{③}$	Thermal Resistance-Junction to Ambient	Steady State	45 °C/W

Note ① : Max. current is limited by bonding

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz

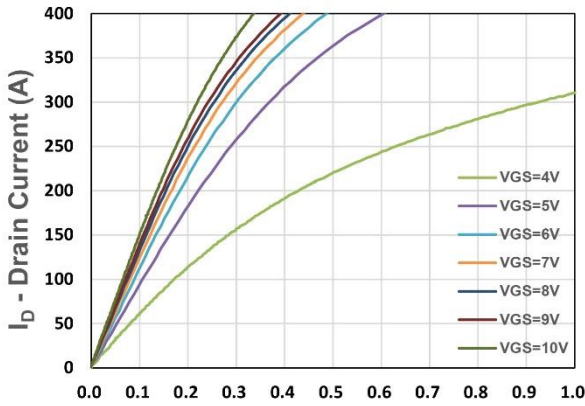
N-Channel Electrical Characteristics (T_J=25°C Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =250uA	40	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	V _{DS} =32V, V _{GS} =0V	-	-	1	uA
V_{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =250uA	1	1.7	2.3	V
I_{GSS}	Gate Leakage Current	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
R_{DS(on)} ^④	Drain-Source On-state Resistance	V _{GS} =10V, I _{DS} =20A	-	0.7	0.9	mΩ
		V _{GS} =4.5V, I _{DS} =10A	-	1.15	1.5	
gfs	Forward Transconductance	V _{DS} =5V, I _{DS} =10A	-	45	-	S
Dynamic Characteristics ^⑤						
R_G	Gate Resistance	V _{GS} =0V, V _{DS} =0V, Freq.=1MHz	-	1.2	-	Ω
C_{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =20V, Freq.=1MHz	-	4928	-	pF
C_{oss}	Output Capacitance		-	2000	-	
C_{rss}	Reverse Transfer Capacitance		-	65	-	
td(ON)	Turn-on Delay Time	V _{GS} =10V, V _{DS} =20V, I _D =20A, R _{GEN} =3Ω	-	10.7	-	nS
t_r	Turn-on Rise Time		-	25.3	-	
t_{d(OFF)}	Turn-off Delay Time		-	65.2	-	
t_f	Turn-off Fall Time		-	53.6	-	
Q_g	Total Gate Charge	V _{GS} =10V, V _{DS} =20V, I _D =20A	-	69	-	nC
Q_{gs}	Gate-Source Charge		-	16.5	-	
Q_{gd}	Gate-Drain Charge		-	10	-	
Source-Drain Characteristics						
V_{SD} ^④	Diode Forward Voltage	I _{SD} =10A, V _{GS} =0V	-	0.72	1.1	V
t_{rr}	Reverse Recovery Time	I _F =20A, V _R =20V	-	48.6	-	nS
Q_{rr}	Reverse Recovery Charge	dI _F /dt=100A/μs	-	35.5	-	nC

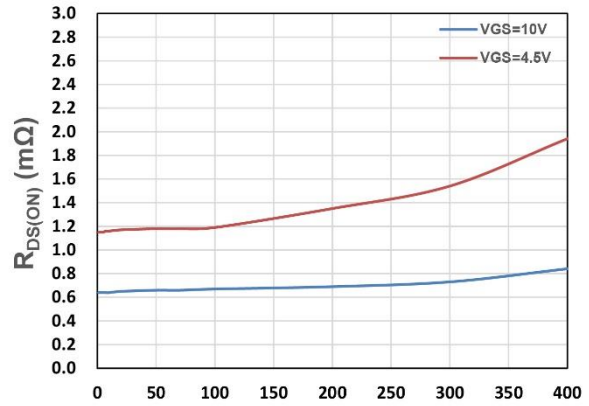
Note ④ : Pulse test (pulse width≤300us, duty cycle≤2%).

Note ⑤ : Guaranteed by design, not subject to production testing.

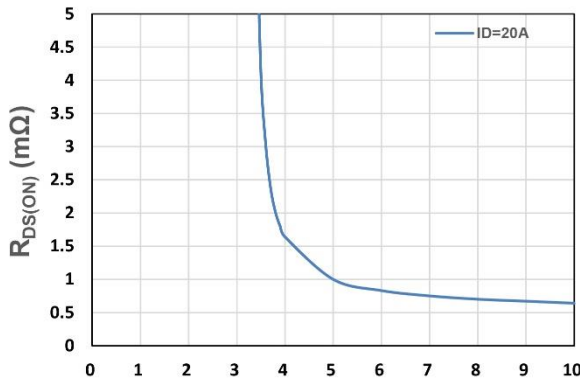
N-Channel Typical Characteristics



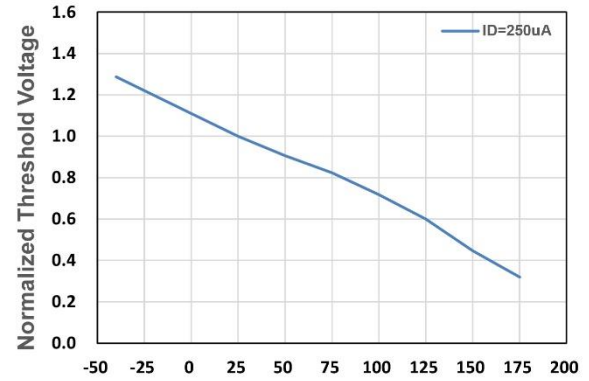
V_{DS} - Drain - Source Voltage (V)
Figure 1. Output Characteristics



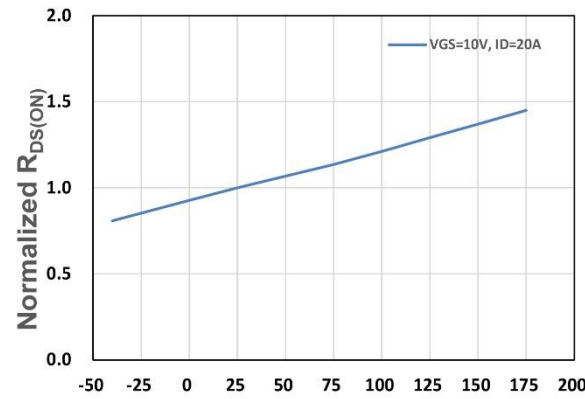
I_D - Drain Current (A)
Figure 2. On-Resistance vs. ID



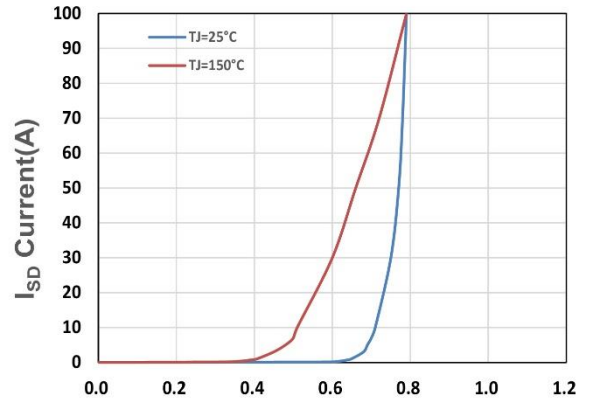
V_{GS} - Gate - Source Voltage (V)
Figure 3. On-Resistance vs. VGS



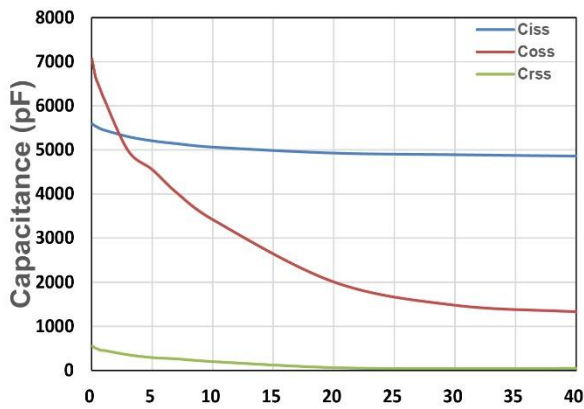
T_j , Junction Temperature ($^{\circ}C$)
Figure 4. Gate Threshold Voltage



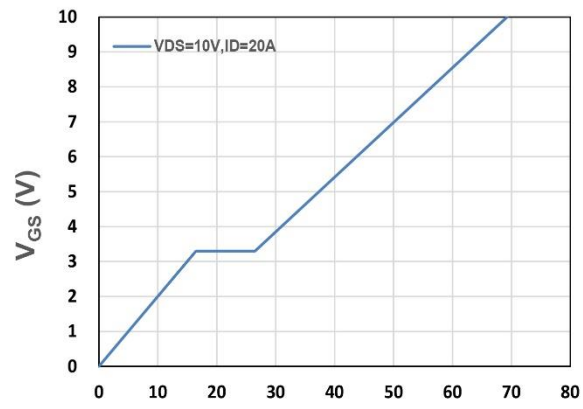
T_j , Junction Temperature ($^{\circ}C$)
Figure 5. Drain-Source On Resistance



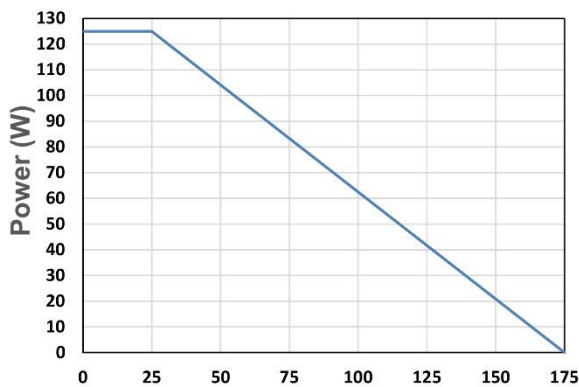
V_{SD} , Source-Drain Voltage (V)
Figure 6. Source-Drain Diode Forward



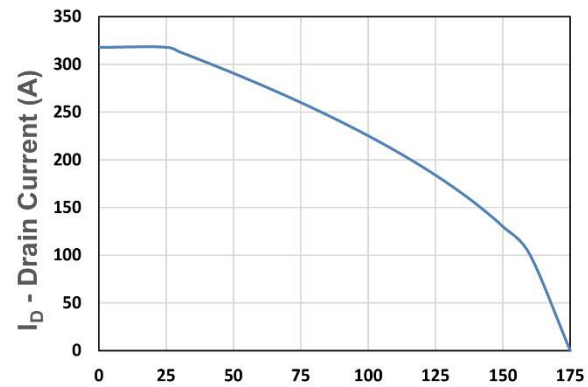
V_{DS} - Drain - Source Voltage (V)
Figure 7. Capacitance



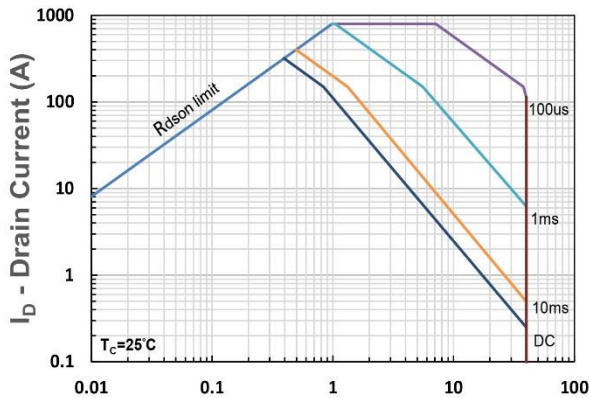
Qg, Total Gate Charge (nC)
Figure 8. Gate Charge Characteristics



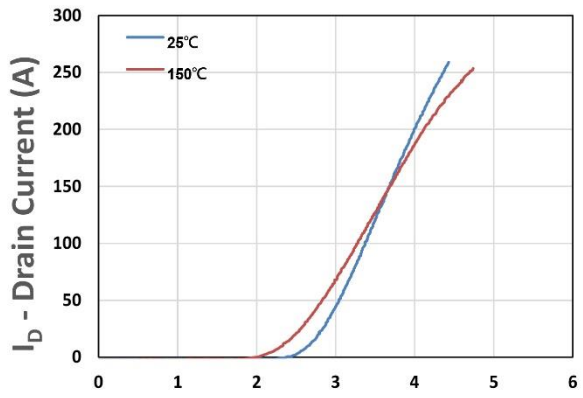
Tc - Case Temperature (°C)
Figure 9. Power Dissipation



Tc - Case Temperature (°C)
Figure 10. Drain Current



V_{DS} - Drain-Source Voltage (V)
Figure 11. Safe Operating Area



V_{GS} - Gate - Source Voltage (V)
Figure 12. Transfer Characteristics

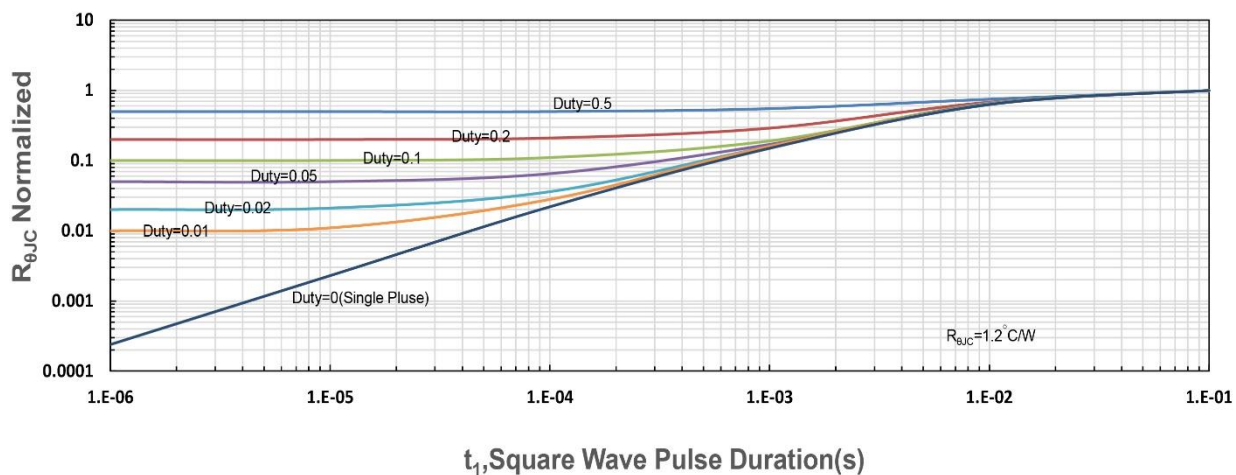


Figure 13. $R_{\theta JC}$ Transient Thermal Impedance

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